SN74AVCB164245 **16-BIT DUAL-SUPPLY BUS TRANSCEIVER**

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

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FEATURES

RUMENTS

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- Member of the Texas Instruments Widebus™ Family
- DOC[™] Circuitry Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- **Dynamic Drive Capability Is Equivalent to** Standard Outputs With I_{OH} and I_{OI} of ±24 mA at 2.5-V V_{CC}
- Control Inputs VIH/VIL Levels Are Referenced to V_{CCB} Voltage
- If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State

- **Overvoltage-Tolerant Inputs/Outputs Allow** Mixed-Voltage-Mode Data Communications
- Ioff Supports Partial-Power-Down Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over Full 1.4-V to 3.6-V **Power-Supply Range**
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA}. V_{CCA} accepts any supply voltage from 1.4 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCB164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCB164245 is designed so that the control pins (1DIR, 2DIR, 1 \overline{OE} , and 2 \overline{OE}) are supplied by V_{CCB}.

To ensure the high-impedance state during power up or power down, OE should be tied to V_{CCB} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either V_{CC} input is at GND, both ports are in the high-impedance state.

T _A	PACKA	GE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	FBGA – GRD	Tape and reel	74AVCB164245GRDR	WD404E	
		Tape and reel	74AVCB164245ZRDR	WB4245	
4000 to 0500	TSSOP – DGG	Tape and reel	SN74AVCB164245GR	AVCB164245	
–40°C to 85°C	TVSOP – DGV	Tape and reel	SN74AVCB164245VR	WB4245	
	VFBGA – GQL	Tape and reel	SN74AVCB164245KR	VVD4240	
	VFBGA – ZQL (Pb-Free) Tape and reel		74AVCB164245ZQLR	WB4245	

ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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TERMINAL ASSIGNMENTS

DGG OR DGV PACKAGE (TOP VIEW)

	1	U	48	
1B1	2		47	1A1
1B2	3		46	1A2
GND	4		45	GND
1B3 🛛	5		44	1A3
1B4 🛛	6		43	1A4
V _{CCB}	7		42	VCCA
1B5	8		41	1A5
1B6 🛛	9		40	1A6
GND [10		39	GND
1B7 🛛	11		38] 1A7
1B8 🛛	12		37] 1A8
2B1 🛛	13		36	2A1
2B2	14		35	2A2
GND 🛛	15		34] GND
2B3 🛛	16		33	2A3
2B4 🛛	17		32	2A4
V _{CCB}	18		31	V _{CCA}
2B5	19		30	2A5
2B6	20		29	2A6
GND	21		28	GND
2B7	22		27	2A7
2B8 🛛	23		26	2A8
2DIR	24		25	2 <u>0</u> E
			_	1

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TERMINAL ASSIGNMENTS (56-Ball GQL/ZQL Package)⁽¹⁾

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 0E
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V _{CCB}	V _{CCA}	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
Е	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	V _{CCB}	V _{CCA}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
к	2DIR	NC	NC	NC	NC	2 <mark>0E</mark>

(1) NC - No internal connection

TERMINAL ASSIGNMENTS (54-Ball GRD/ZRD Package)⁽¹⁾

	1	2	3	4	5	6
Α	1B1	NC	1DIR	1 <mark>0E</mark>	NC	1A1
В	1B3	1B2	NC	NC	1A2	1A3
С	1B5	1B4	V _{CCB}	V _{CCA}	1A4	1A5
D	1B7	1B6	GND	GND	1A6	1A7
Е	2B1	1B8	GND	GND	1A8	2A1
F	2B3	2B2	GND	GND	2A2	2A3
G	2B5	2B4	V _{CCB}	V _{CCA}	2A4	2A5
н	2B7	2B6	NC	NC	2A6	2A7
J	2B8	NC	2DIR	2 <mark>0E</mark>	NC	2A8

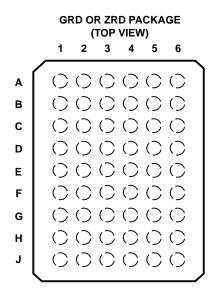
(1) NC - No internal connection

FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Х	Isolation

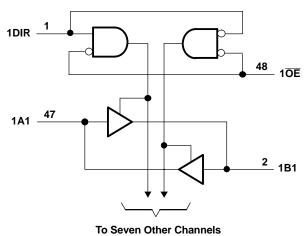
GQL OR ZQL PACKAGE (TOP VIEW)

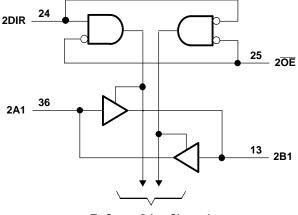
	_1	2	3	4	5	6	_
АÍ	0	0	0	0	0	0	
в	0	O	\bigcirc	0	()	()	
С	()	0	O	()	()	0	
D	()	()	()	()	()	()	
Е	()	()			()	()	
F	0	(()	0	
G	()	()	()	()	()	()	
н	0	О	О	0	О	0	
J	()	()	()	()	()	()	
κ	()	0	()	()	0	()	



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LOGIC DIAGRAM (POSITIVE LOGIC)





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To Seven Other Channels

Pin numbers shown are for the DGG and DGV packages.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CCA} V_{CCB}	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Input voltage range ⁽²⁾	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output in the high-impedance or	A port	-0.5	4.6	V
Vo	power-off state ⁽²⁾	B port	-0.5	4.6	v
V	Voltage range explicitly even with the high or law state $\binom{2}{3}$	A port	-0.5	V _{CCA} + 0.5	V
Vo	Voltage range applied to any output in the high or low state $^{(2)}$ $^{(3)}$	B port	-0.5	V _{CCB} + 0.5	v
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V ₀ < 0		-50	mA
lo	Continuous output current			50	mA
	Continuous current through V _{CCA} , V _{CCB} , or GND			100	mA
		DGG package		70	
0	Continuous output current Continuous current through V _{CCA} , V _{CCB} , or GND	DGV package		58	0000
θ_{JA}	Package mermai impedance	GQL/ZQL package		28	°C/W
		GRD/ZRD package		36	
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.



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Recommended Operating Conditions⁽¹⁾⁽²⁾⁽³⁾

over operating free-air temperature range (unless otherwise noted)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT	
V _{CCA}	Supply voltage				1.4	3.6	V	
V _{CCB}	Supply voltage				1.4	3.6	V	
			1.4 V to 1.95 V		$V_{CCI} imes 0.65$			
VIH	High-level input voltage	Data inputs	1.95 V to 2.7 V		1.7		V	
			2.7 V to 3.6 V		2			
			1.4 V to 1.95 V			$V_{CCI} imes 0.35$		
V _{IL}	Low-level input voltage	Data inputs	1.95 V to 2.7 V			0.7	V	
			2.7 V to 3.6 V			0.8		
			1.4 V to 1.95 V		$V_{CCB} imes 0.65$			
V _{IH}	High-level input voltage	Control inputs (referenced to V _{CCB})	1.95 V to 2.7 V		1.7		V	
			(referenced to vCCB)	2.7 V to 3.6 V		2		
			1.4 V to 1.95 V			$V_{\text{CCB}} \times 0.35$		
V _{IL}	Low-level input voltage	Control inputs (referenced to V _{CCB})	1.95 V to 2.7 V			0.7	V	
		(Information of CCB)	2.7 V to 3.6 V			3.6 V _{CCI} × 0.35 0.7 0.8 V _{CCB} × 0.35 0.7 0.7 0.8 3.6 V _{CCO} 3.6 -2 -4 -4 -4 -8 -12 2 4 8 8 12 5		
VI	Input voltage				0	3.6	V	
V		Active state			0	V _{cco}	V	
Vo	Output voltage	3-state			0	3.6	v	
				1.4 V to 1.6 V		-2		
	High-level output current	-		1.65 V to 1.95 V		-4	mA	
I _{OH}				2.3 V to 2.7 V		-8	mA	
				3 V to 3.6 V		-12		
				1.4 V to 1.6 V		2		
	Low lovel output ourrest	=		1.65 V to 1.95 V		4	mA	
OL	I _{OL} Low-level output current	_		2.3 V to 2.7 V		8	ША	
				3 V to 3.6 V		12		
$\Delta t / \Delta v$	Input transition rise or fall	rate				5	ns/V	
T _A	Operating free-air temperation	ature			-40	85	°C	

(1)

 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the data output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004. (2) (3)

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Electrical Characteristics⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

P	ARAMETER	TEST COND	ITIONS	V _{CCA}	V _{CCB}	MIN	TYP ⁽³⁾	MAX	UNIT	
		I _{OH} = −100 μA	$V_{I} = V_{IH}$	1.4 V to 3.6 V	1.4 V to 3.6 V	V _{CCO} - 0.2				
		$I_{OH} = -2 \text{ mA}$	$V_{I} = V_{IH}$	1.4 V	1.4 V	1.05				
V _{ОН}		$I_{OH} = -4 \text{ mA}$	$V_{I} = V_{IH}$	1.65 V	1.65 V	1.2			V	
		$I_{OH} = -8 \text{ mA}$	$V_{I} = V_{IH}$	2.3 V	2.3 V	1.75				
		I _{OH} = -12 mA	$V_{I} = V_{IH}$	3 V	3 V	2.3				
		I _{OH} = 100 μA	$V_{I} = V_{IL}$	1.4 V to 3.6 V	1.4 V to 3.6 V			0.2		
		I _{OH} = 2 mA	$V_{I} = V_{IL}$	1.4 V	1.4 V			0.35		
V _{OL}		I _{OH} = 4 mA	$V_{I} = V_{IL}$	1.65 V	1.65 V			0.45	V	
		I _{OH} = 8 mA	$V_{I} = V_{IL}$	2.3 V	2.3 V			0.55		
		I _{OH} = 12 mA	$V_{I} = V_{IL}$	3 V	3 V			0.7		
I	Control inputs	$V_{I} = V_{CCB}$ or GND		1.4 V to 3.6 V	3.6 V			±2.5	μA	
	A port			0 V	0 to 3.6 V			±10	^	
off	B port	- V _I or V _O = 0 to 3.6 V	0 to 3.6 V 0 to 3.6 V 0 V					±10	μA	
	A or B ports		$\overline{OE} = V_{IH}$	3.6 V	3.6 V			±12.5		
oz ⁽⁴⁾	B port	$V_0 = V_{CC0}$ or GND, $V_1 = V_{CC1}$ or GND	$\overline{OE} = don't$	0 V	3.6 V			±12.5	μA	
	A port		care	3.6 V	0 V			±12.5		
				1.6 V	1.6 V			20		
				1.95 V	1.95 V			20	-	
				2.7 V	2.7 V			30		
CCA		$V_I = V_{CCI}$ or GND,	$I_{O} = 0$	0 V	3.6 V			-40	μA	
				3.6 V	0 V			40		
				3.6 V	3.6 V			40		
				1.6 V	1.6 V			20		
				1.95 V	1.95 V			20		
			1 – 0	2.7 V	2.7 V			30		
Іссв	$V_I = V_{CCI}$ or GND,	1 ₀ = 0	0 V	3.6 V			40	μA		
			3.6 V	0 V			-40)		
				3.6 V	3.6 V			40		
C _i	Control inputs	$V_I = 3.3 \text{ V or GND}$		3.3 V	3.3 V		4		pF	
C _{io}	A or B ports	$V_{O} = 3.3 \text{ V or GND}$		3.3 V	3.3 V		5		pF	

V_{CCO} is the V_{CC} associated with the output port.
 V_{CCI} is the V_{CC} associated with the input port.
 All typical values are at T_A = 25°C.
 For I/O ports, the parameter I_{OZ} includes the input leakage current.

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 2)

PARAMETER	FROM	FROM TO		V _{CCB} = 1.5 V 0.1 V		V _{CCB} = 1.8 V 0.15 V		V _{CCB} = 2.5 V 0.2 V		V _{CCB} = 3.3 V 0.3 V	
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{pd}	А	В	1.7	6.7	1.9	6.3	1.8	5.5	1.7	5.8	
	В	А	1.8	6.8	2.2	7.4	2.1	7.6	2.1	7.3	ns
		А	2.5	8.4	2.4	7.4	2.1	5.2	1.9	4.2	20
t _{en}	ŌĒ	В	2.1	9	2.9	9.8	3.2	10	3	9.8	ns
t _{dis}	ŌĒ	А	2.2	6.9	2.3	6.1	1.3	3.6	1.3	3	
	ÛE	В	2.1	7.1	2.3	6.4	1.7	5.1	1.6	4.8	ns

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 2)

PARAMETER	FROM TO (INPUT) (OUTPUT)			V _{CCB} = 1.5 V 0.1 V		V _{CCB} = 1.8 V 0.15 V		V _{CCB} = 2.5 V 0.2 V		V _{CCB} = 3.3 V 0.3 V	
	(INPOT)	(001-01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Α	В	1.7	6.7	1.8	6	1.7	4.7	1.6	4.3	20
t _{pd}	В	А	1.4	5.5	1.8	6	1.8	5.8	1.8	5.5	ns
+	ŌĒ	А	2.6	8.5	2.5	7.5	2.2	5.3	1.9	4.2	20
t _{en}	UE	В	B 1.8 7.6 2.6	2.6	2.6 7.7	2.6	7.6	2.6	7.4	ns	
	ŌĒ	А	2.3	7	2.3	6.1	1.3	3.6	1.3	3	20
t _{dis}	UE	В	1.8	7	2.5	6.3	1.8	4.7	1.7	4.4	ns

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 2)

PARAMETER	FROM	TO	V _{CCB} = 1.5 V 0.1 V		V _{CCB} = 1.8 V 0.15 V		V _{CCB} = 2.5 V 0.2 V		V _{CCB} = 3.3 V 0.3 V		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	А	В	1.6	6	1.8	5.6	1.5	4	1.4	3.4	~~
t _{pd}	В	А	1.3	4.6	1.7	4.4	1.5	4	1.4	3.7	ns
	OE	А	3.1	8.5	2.5	7.5	2.2	5.3	1.9	4.2	~~
t _{en}	ÛE	В	1.7	5.7	2.2	5.5	2.2	5.3	2.2	5.1	ns
		А	2.4	7	3	6.1	1.4	3.6	1.2	3	ns
t _{dis}	ŌĒ	В	1.2	5.8	1.9	5	1.4	3.6	1.3	3.3	

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 0.7	1.5 V 1 V	V _{ССВ} = 0.1	1.8 V 5 V	V _{CCB} = 0.2	2.5 V 2 V	V _{CCB} = 0.3	3.3 V 3 V	UNIT
	(INPOT)	(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	A	В	1.5	5.9	1.7	5.4	1.5	3.7	1.4	3.1	20
t _{pd}	В	А	1.3	4.5	1.6	3.8	1.5	3.3	1.4	3.1	ns
+	ŌE	А	2.6	8.3	2.5	7.4	2.2	5.2	1.9	4.1	20
Len		ÛE	В	1.6	4.9	2	4.5	2	4.3	1.9	4.1
	ŌE	А	2.3	7	3	6	1.3	3.5	1.2	3.5	
t _{dis}		UE	В	1.3	6.9	2.1	5.5	1.6	3.8	1.5	3.5



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Operating Characteristics

 V_{CCA} and V_{CCB} = 3.3 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT		
	Power dissipation capacitance per transceiver,	Outputs enabled		14		
CndA	A-port input, B-port output	Outputs disabled		7		
C _{pdA} (V _{CCA})	Power dissipation capacitance per transceiver,	Outputs enabled	$C_L = 0, f = 10 \text{ MHz}$	20	pF	
	B-port input, A-port output	Outputs disabled		7		
	Power dissipation capacitance per transceiver,	Outputs enabled		20		
C _{pdB}	A-port input, B-port output	Outputs disabled		7	- 5	
C _{pdB} (V _{CCB})	Power dissipation capacitance per transceiver,	Outputs enabled	$C_{L} = 0, f = 10 \text{ MHz}$	14	pF	
	B-port input, A-port output	Outputs disabled		7		

Output Description

The DOCTM circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical V_{OL} vs I_{OL} and V_{OH} vs I_{OH} curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, AVC Logic Family Technology and Applications, literature number SCEA006, and Dynamic Output Control (DOCTM) Circuitry Technology and Applications, literature number SCEA009.

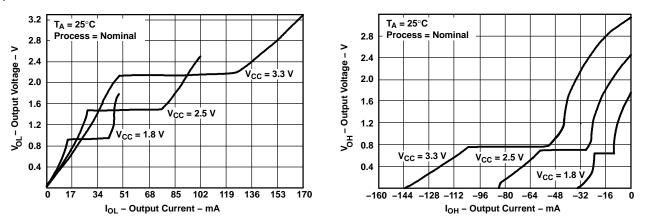
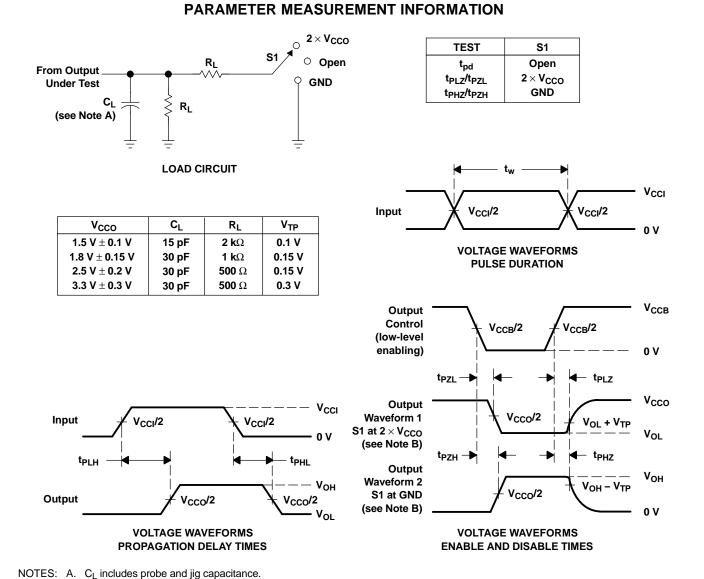


Figure 1. Typical Output Voltage vs Output Current



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B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

- Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , dv/dt \geq 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 2. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
	(.)		Ū			(-)	(6)	(0)		(10)	
74AVCB164245GRE4	ACTIVE	TSSOP	DGG	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCB164245	Samples
SN74AVCB164245GR	ACTIVE	TSSOP	DGG	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCB164245	Samples
SN74AVCB164245VR	ACTIVE	TVSOP	DGV	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WB4245	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

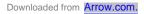
OTHER QUALIFIED VERSIONS OF SN74AVCB164245 :

• Automotive : SN74AVCB164245-Q1

Enhanced Product : SN74AVCB164245-EP

NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications



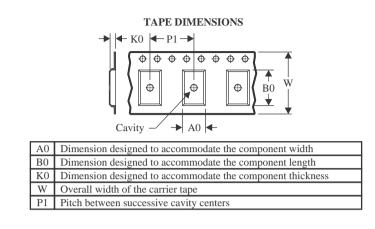


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AVCB164245GR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74AVCB164245VR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All dimensions are nominal

ſ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	SN74AVCB164245GR	TSSOP	DGG	48	2000	367.0	367.0	45.0
	SN74AVCB164245VR	TVSOP	DGV	48	2000	356.0	356.0	35.0

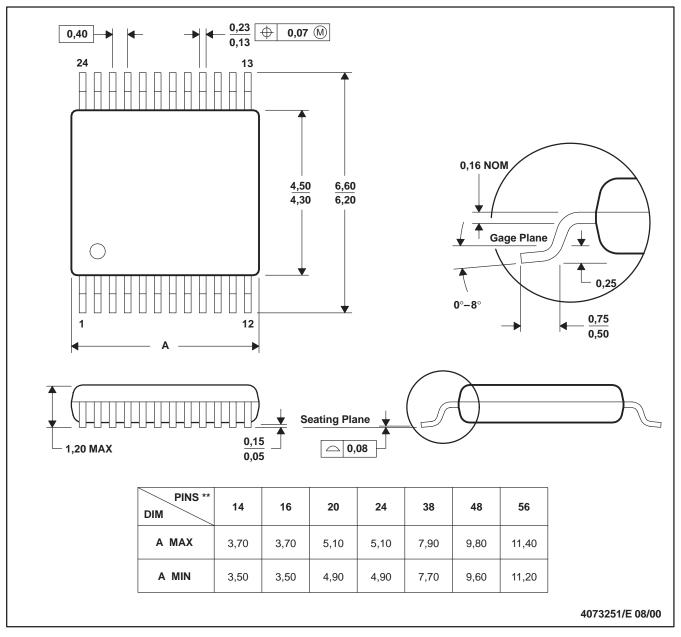
MECHANICAL DATA

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

DGG0048A

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not

- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-153.

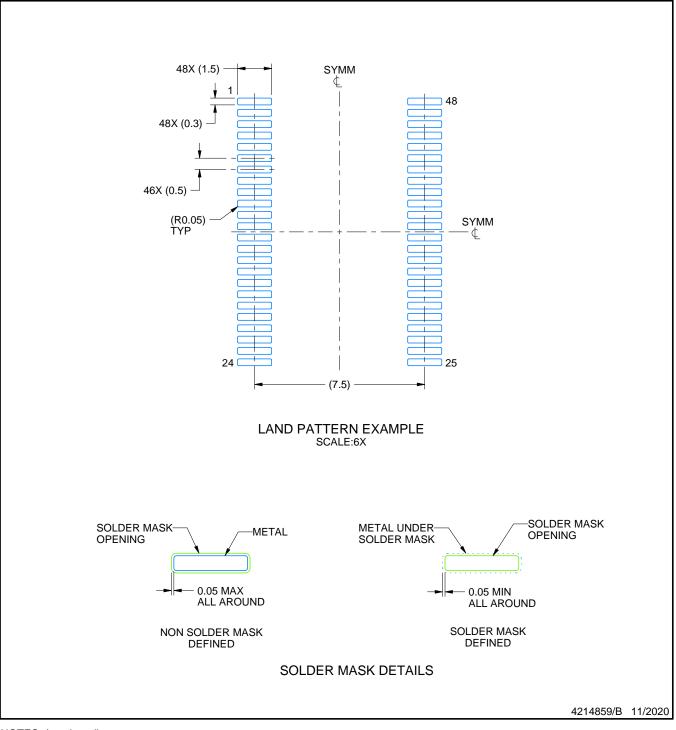


DGG0048A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

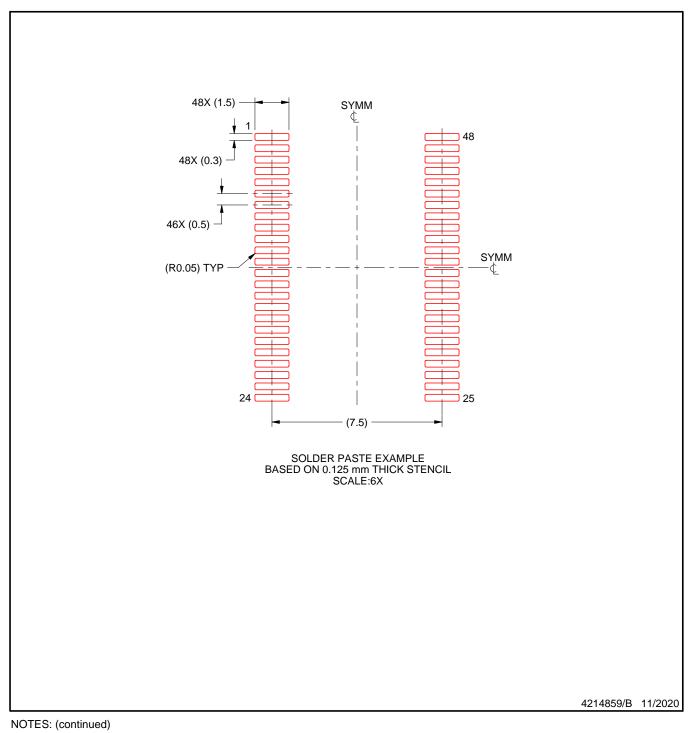


DGG0048A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



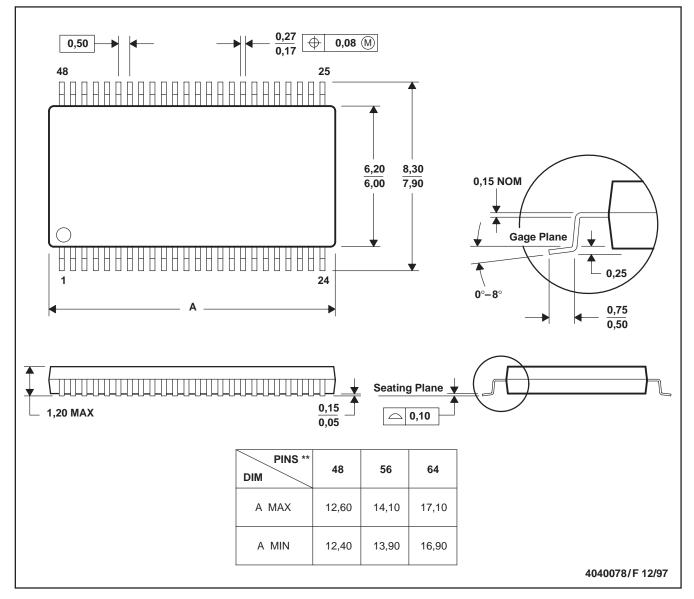
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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